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April 1st, 2010
Renesas Electronics Corporation

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3803 Group (Spec.H)

List of Registers

1. Abstract

The following article describes the control registers of the 3803 Group (Spec.H).

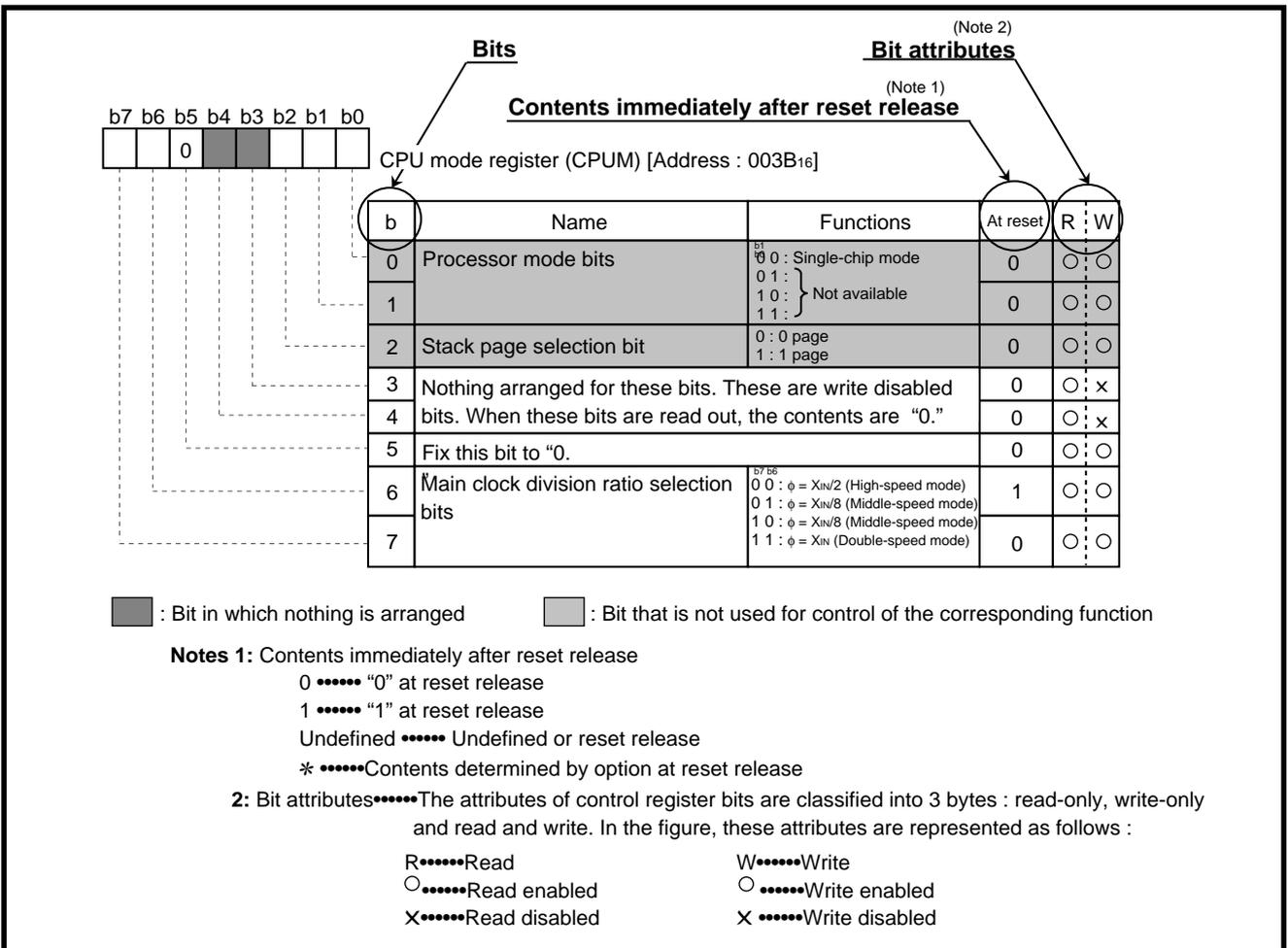
2. Introduction

The explanation of this issue is applied to the following condition:

Applicable MCU: 3803 Group (Spec.H)

3. Structure of Register

The figure of each register structure describes its functions, contents at reset, and attributes as follows:



4 List of registers

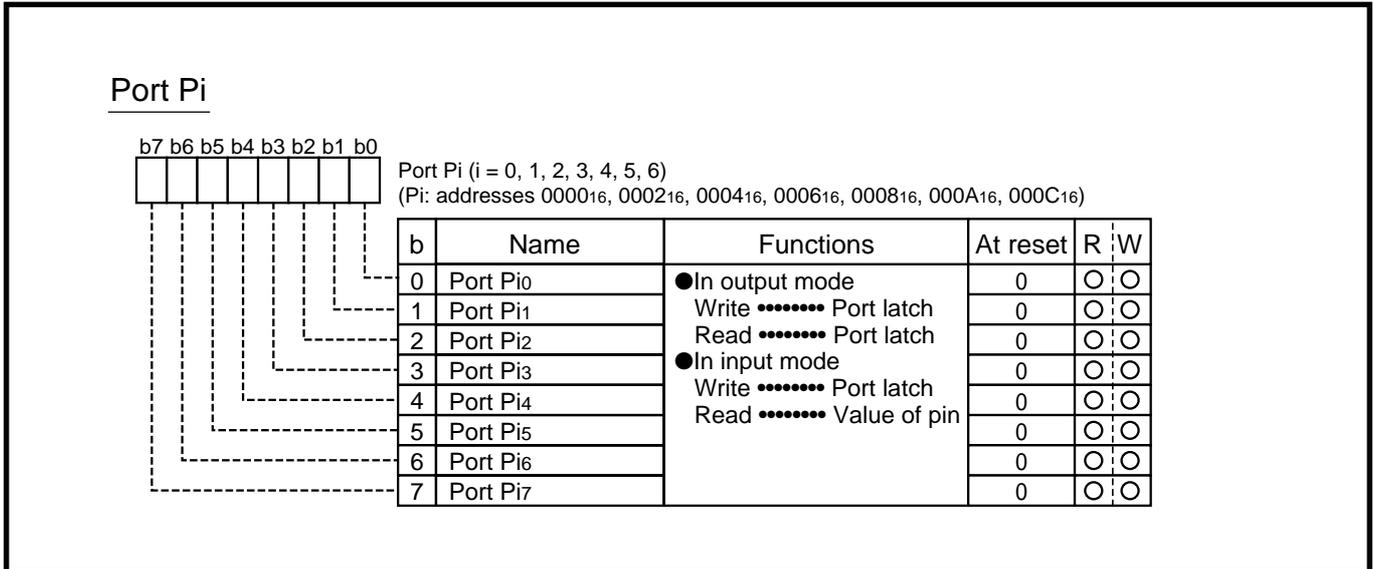


Fig. 4.1 Structure of Port Pi

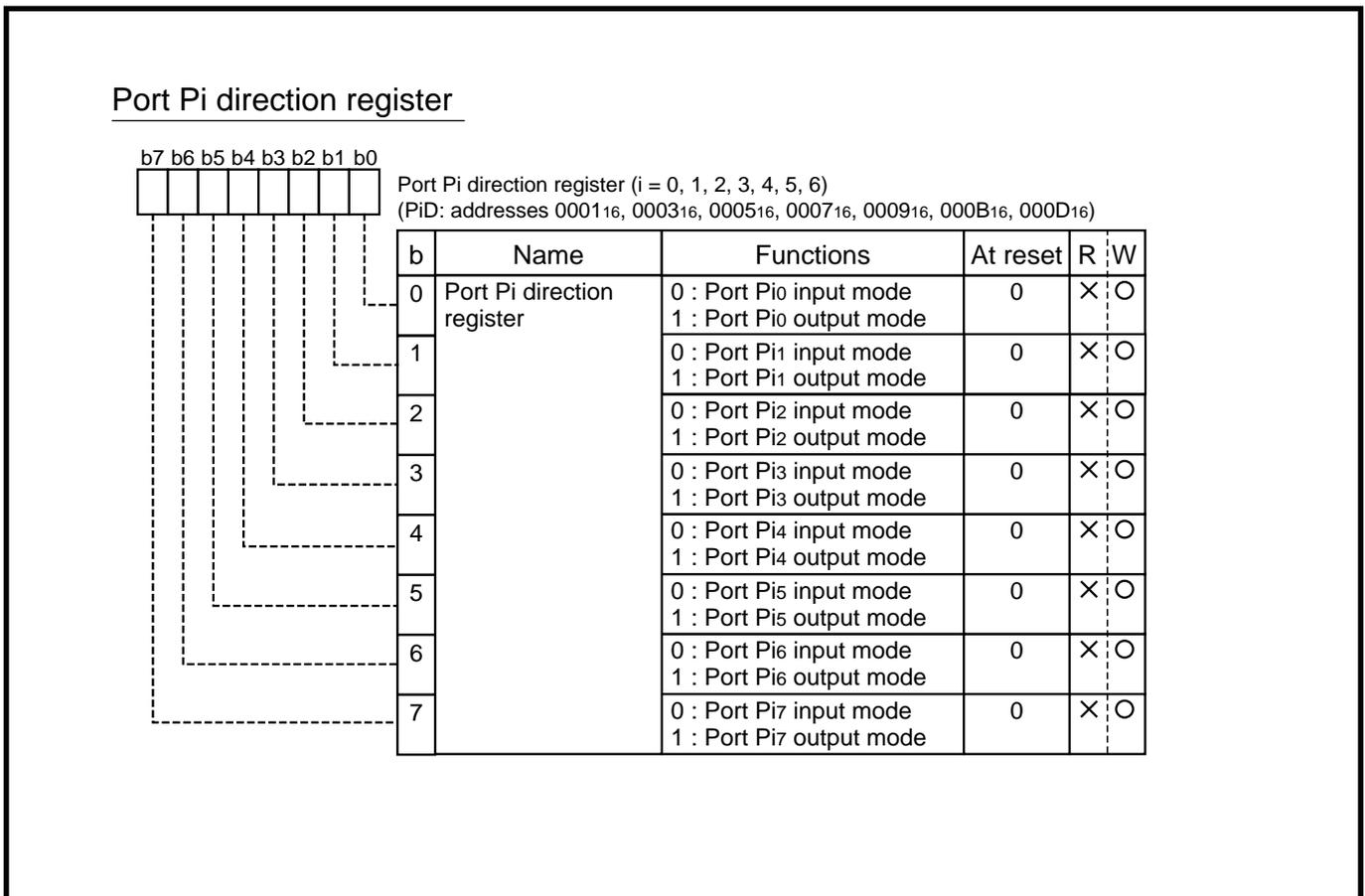


Fig. 4.2 Structure of Port Pi direction register

Timer 12, X count source selection register

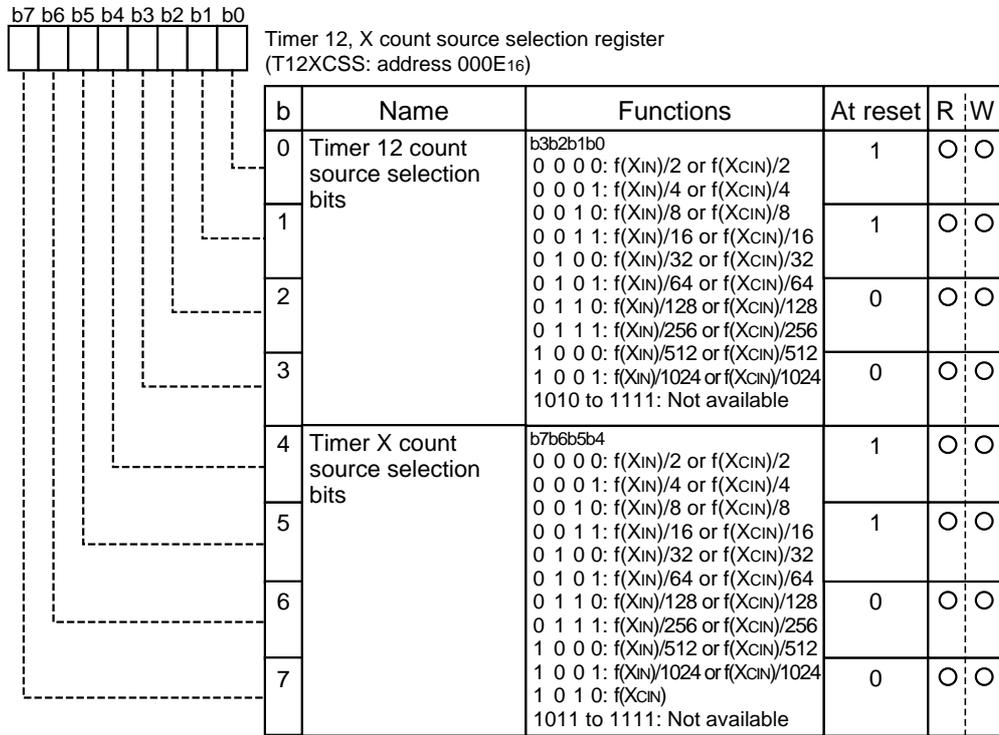


Fig. 4.3 Structure of Timer 12, X count source selection register

Timer Y, Z count source selection register

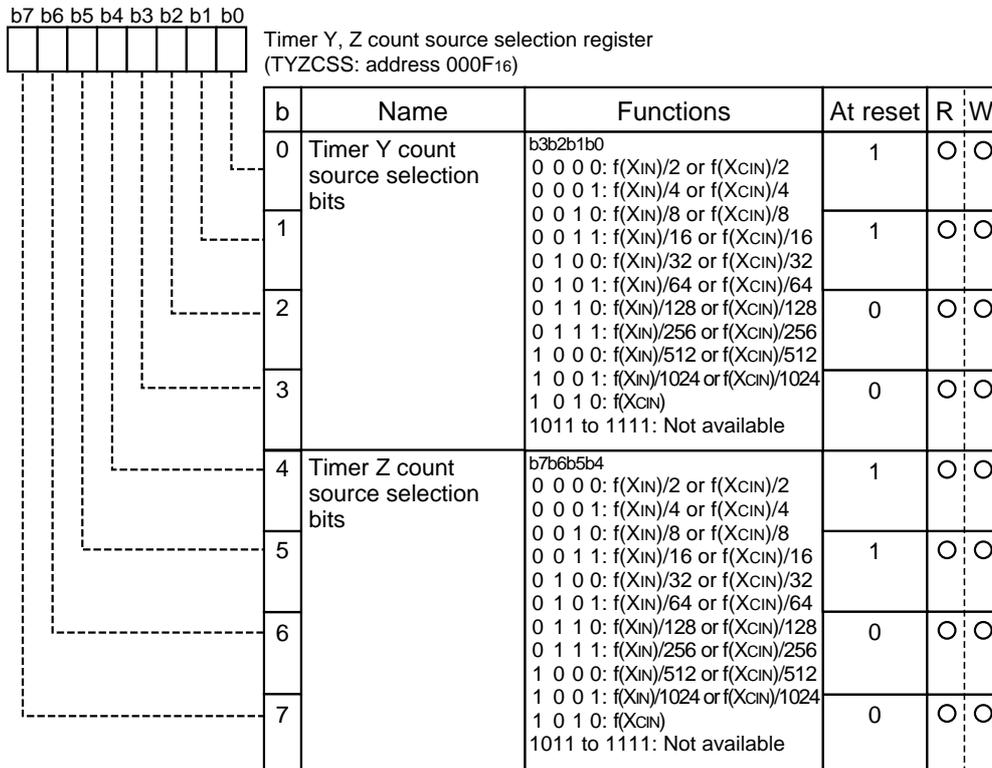
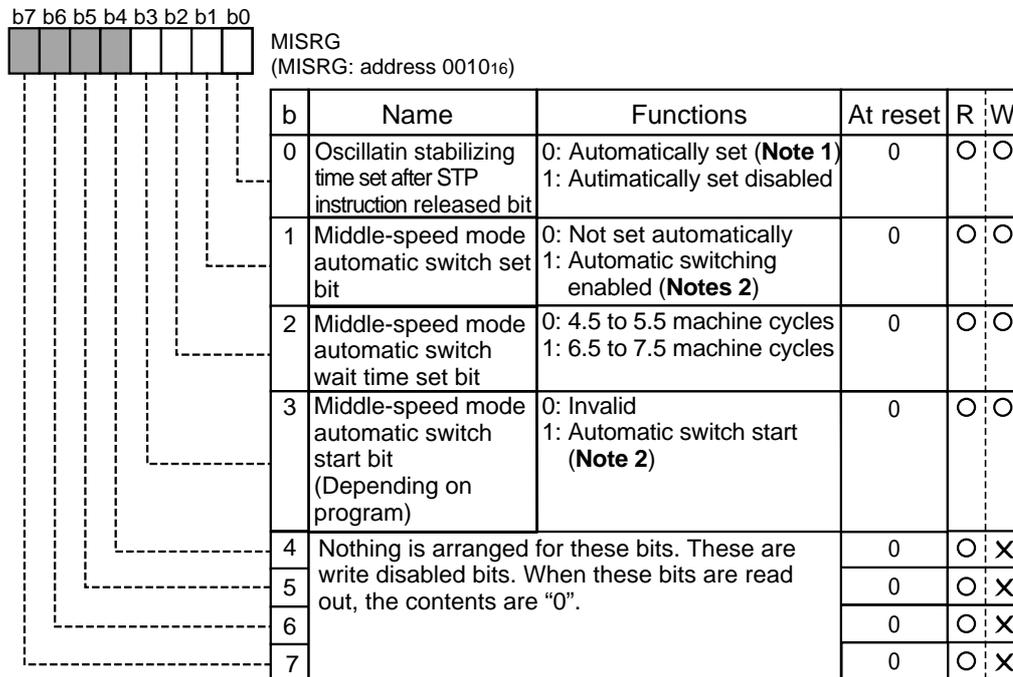


Fig. 4.4 Structure of Timer Y, Z count source selection register

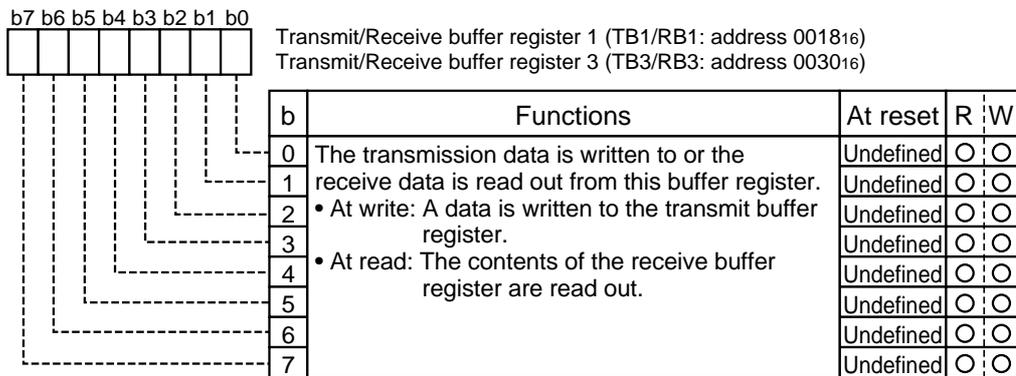
MISRG



Notes 1: "01₁₆" is set to Timer 1, "FF₁₆" is set to Prescaler 12.
2: When automatic switch to middle-speed mode from low-speed mode occurs, the values of CPU mode register (003B₁₆) change.

Fig. 4.5 Structure of MISRG

Transmit/Receive buffer register 1, Transmit/Receive buffer register 3



Note: The contents of transmit buffer register cannot be read out. The data cannot be written to the receive buffer register.

Fig. 4.6 Structure of Transmit/Receive buffer register 1, Transmit/Receive buffer register 3

Serial I/O1 status register, Serial I/O3 status register

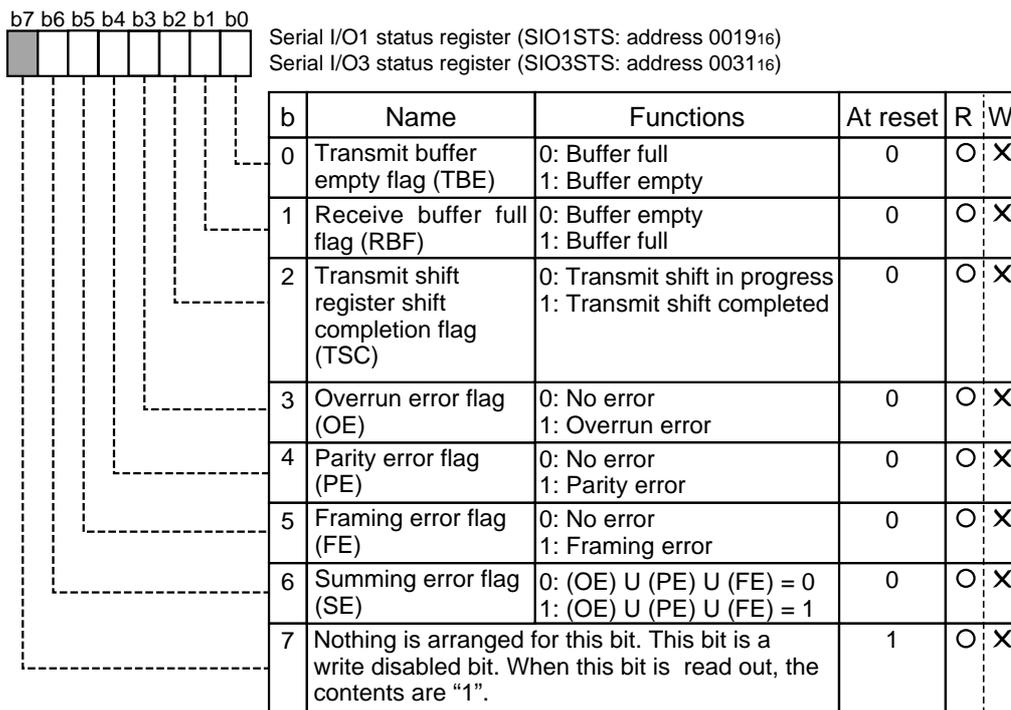


Fig. 4.7 Structure of Serial I/O1 status register, Serial I/O3 status register

Serial I/O1 control register

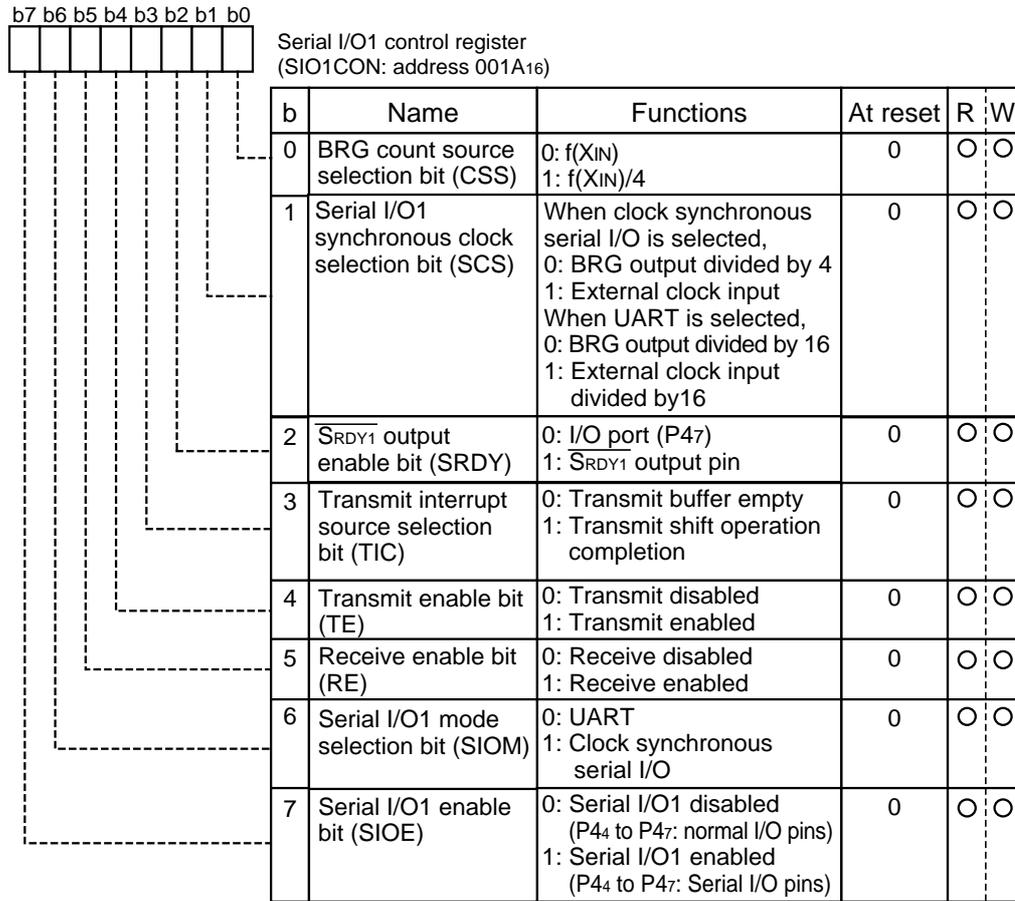


Fig. 4.8 Structure of Serial I/O1 control register

UART1 control register

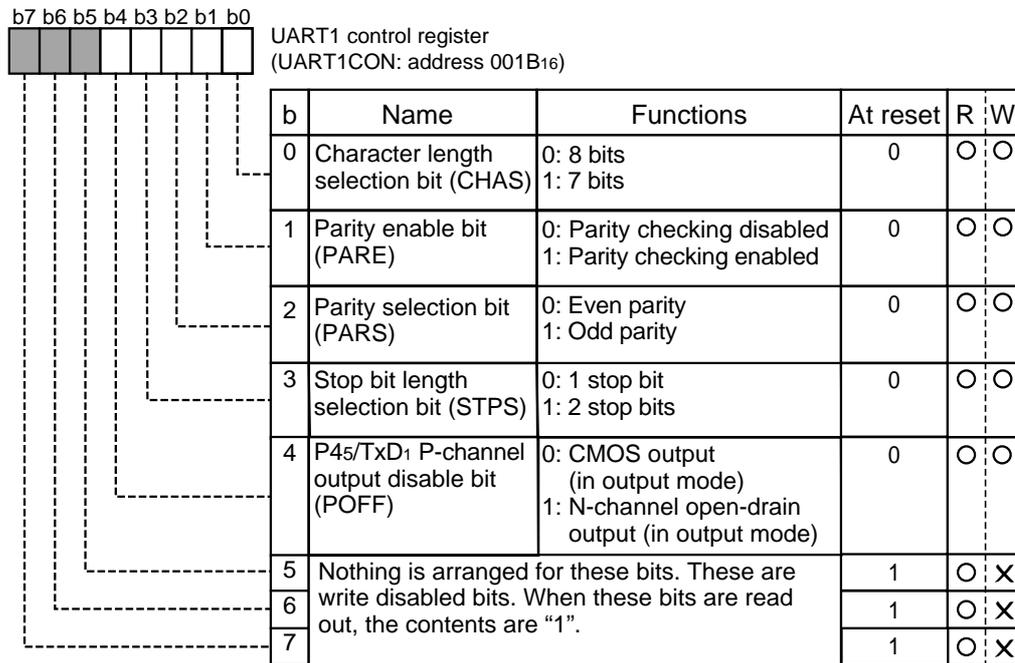
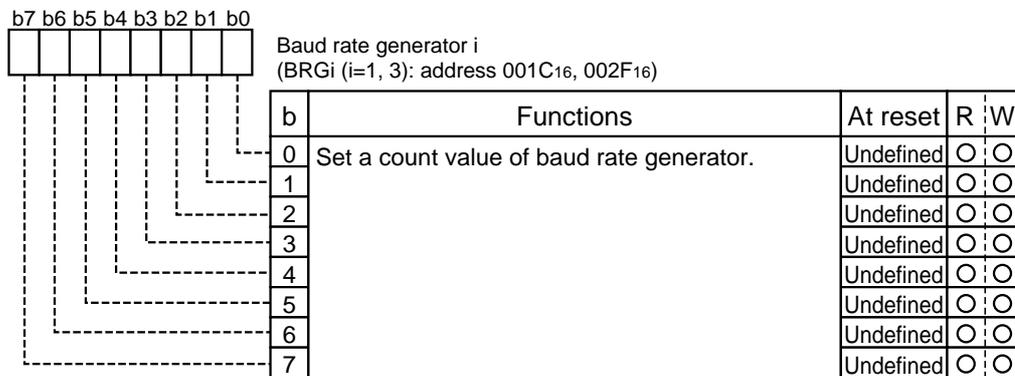


Fig. 4.9 Structure of UART1 control register

Baud rate generator i (i = 1, 3)



Note: Write to this register while transmit/receive operation is stopped.

Fig. 4.10 Structure of Baud rate generator i

Serial I/O2 control register

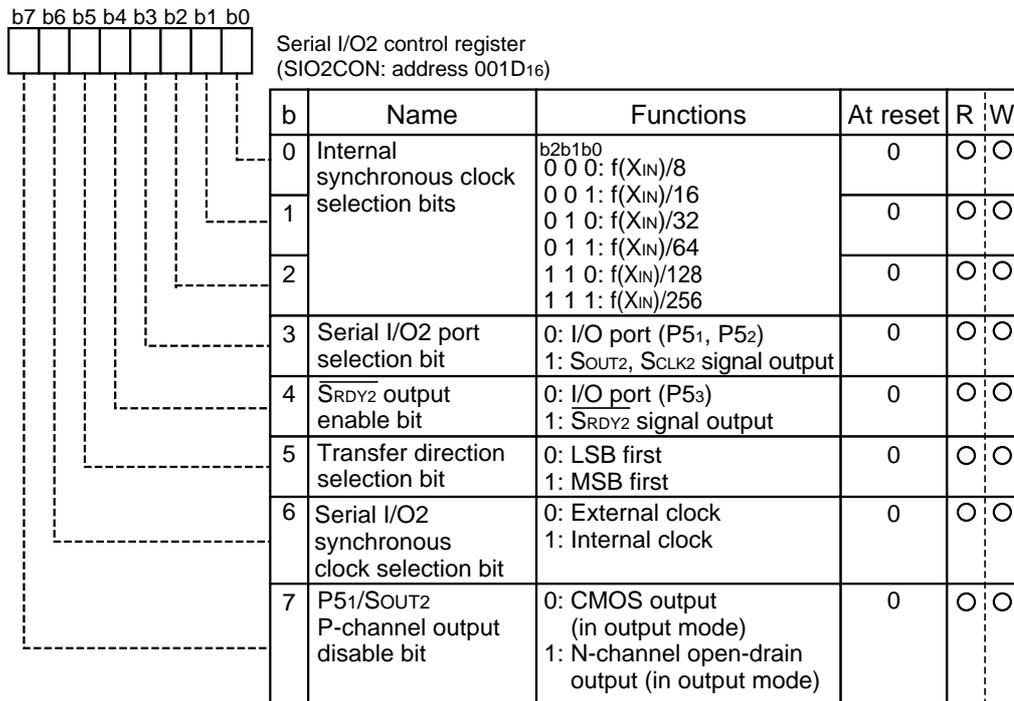


Fig. 4.11 Structure of Serial I/O2 control register

Watchdog timer control register

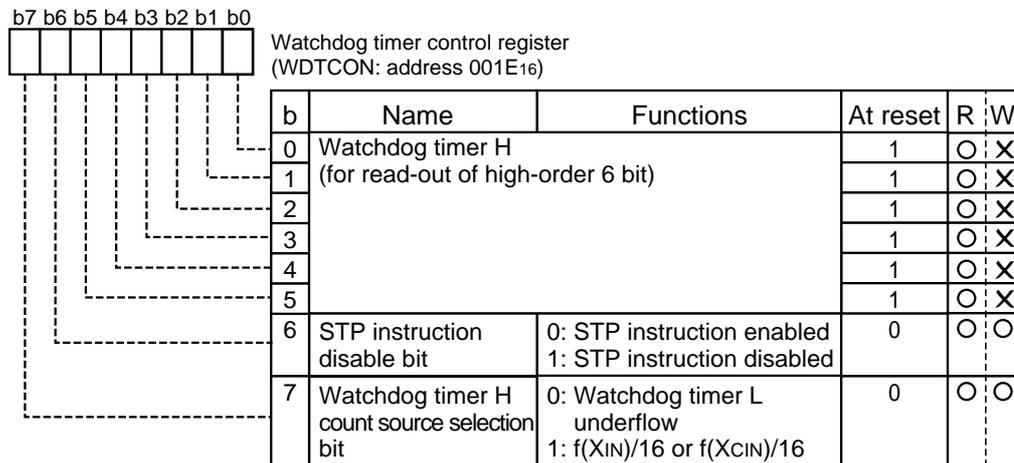


Fig. 4.12 Structure of Watchdog timer control register

Serial I/O2 register

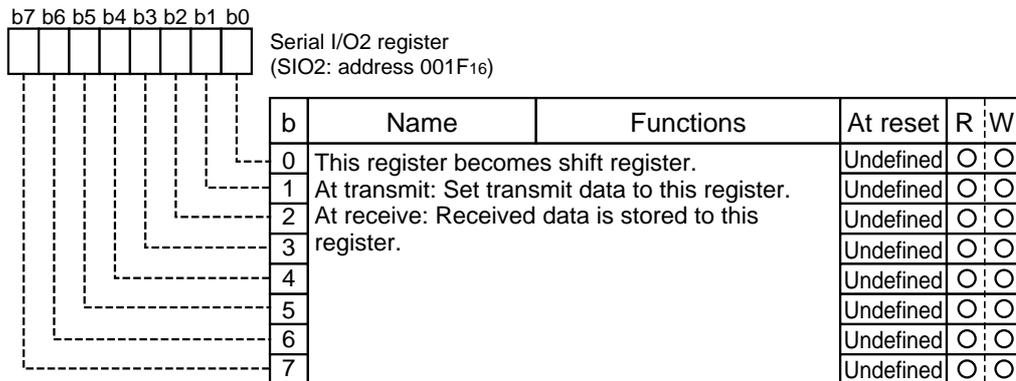


Fig. 4.13 Structure of Serial I/O2 register

Prescaler 12, Prescaler X, Prescaler Y

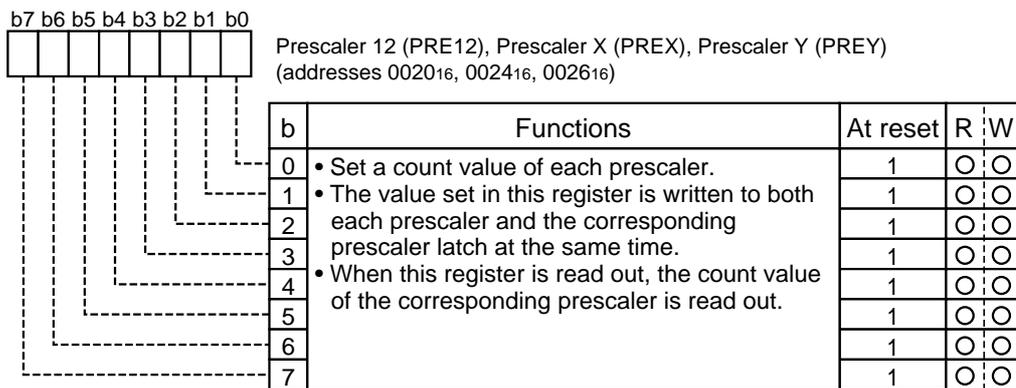


Fig. 4.14 Structure of Prescaler 12, Prescaler X, Prescaler Y

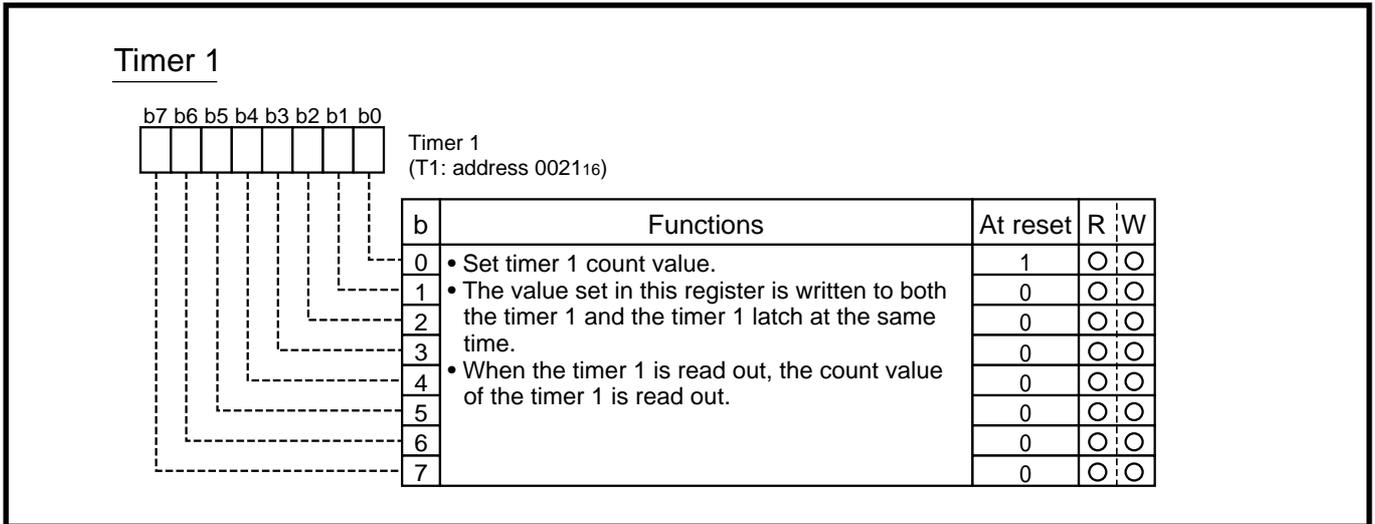


Fig. 4.15 Structure of Timer 1

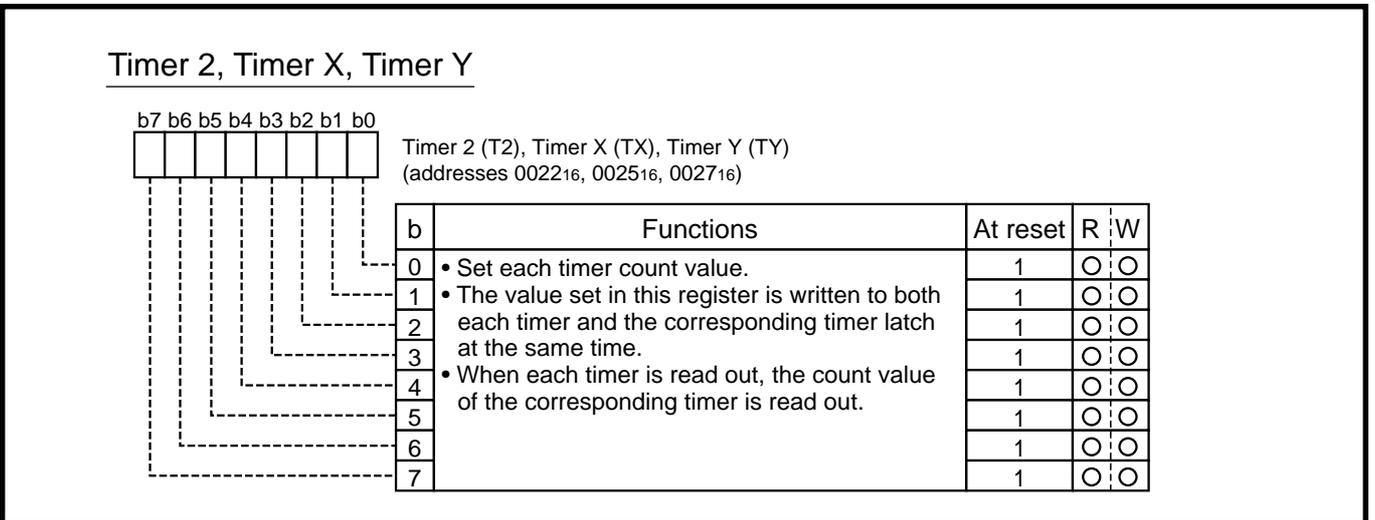


Fig. 4.16 Structure of Timer 2, Timer X, Timer Y

Timer XY mode register

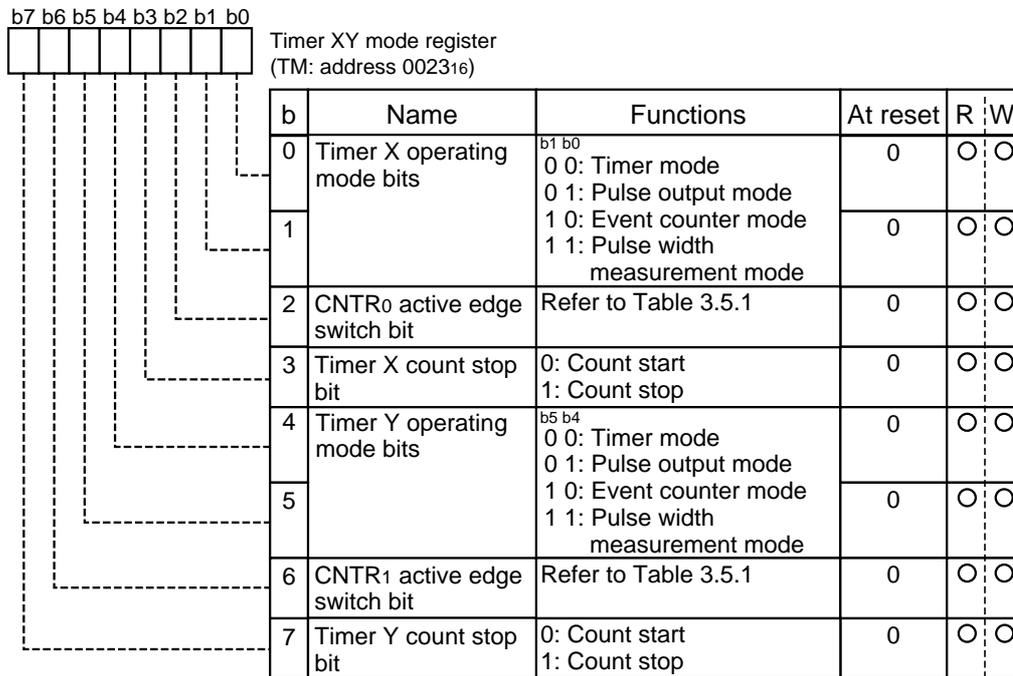


Fig. 4.17 Structure of Timer XY mode register

Table 4.1 CNTR₀/CNTR₁ active edge switch bit function

Timer X/Timer Y operation modes	CNTR ₀ /CNTR ₁ active edge switch bit (bits 2 and 6 of address 0023 ₁₆) contents
Timer mode	"0" CNTR ₀ /CNTR ₁ interrupt request occurrence: Falling edge ; No influence to timer count
	"1" CNTR ₀ /CNTR ₁ interrupt request occurrence: Rising edge ; No influence to timer count
Pulse output mode	"0" Pulse output start: Beginning at "H" level CNTR ₀ /CNTR ₁ interrupt request occurrence: Falling edge
	"1" Pulse output start: Beginning at "L" level CNTR ₀ /CNTR ₁ interrupt request occurrence: Rising edge
Event counter mode	"0" Timer X/Timer Y: Rising edge count CNTR ₀ /CNTR ₁ interrupt request occurrence: Falling edge
	"1" Timer X/Timer Y: Falling edge count CNTR ₀ /CNTR ₁ interrupt request occurrence: Rising edge
Pulse width measurement mode	"0" Timer X/Timer Y: "H" level width measurement CNTR ₀ /CNTR ₁ interrupt request occurrence: Falling edge
	"1" Timer X/Timer Y: "L" level width measurement CNTR ₀ /CNTR ₁ interrupt request occurrence: Rising edge

Timer Z low-order, Timer Z high-order

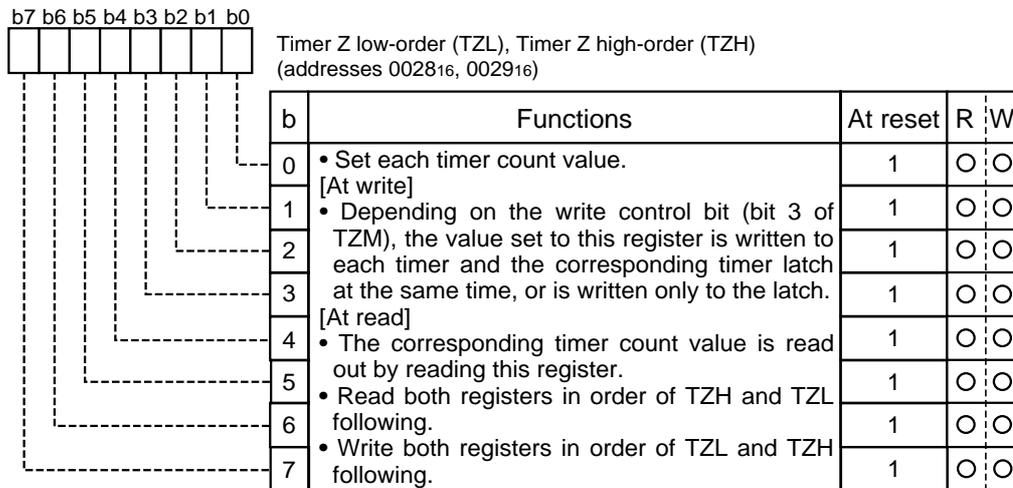
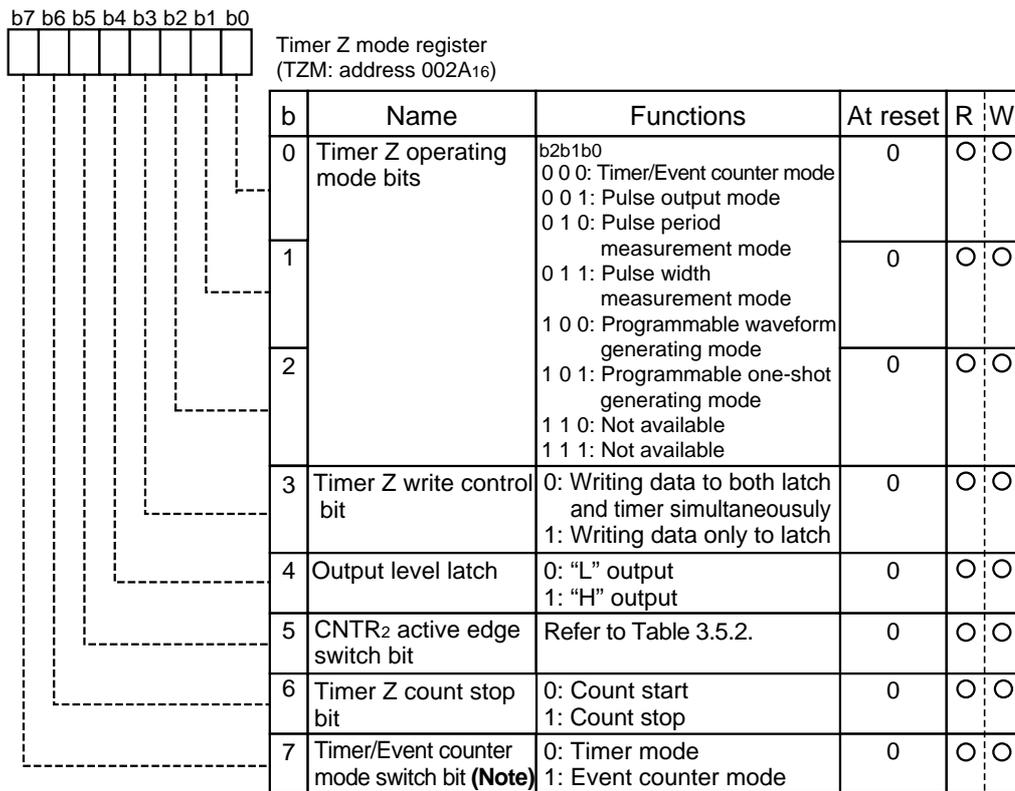


Fig. 4.18 Structure of Timer Z low-order, Timer Z high-order

Timer Z mode register



Note: When selecting the modes except the timer/event counter mode, set "0" to this bit.

Fig. 4.19 Structure of Timer Z mode register

Table 4.2 CNTR₂ active edge switch bit function

Timer Z operation modes	CNTR ₂ active edge switch bit (bit 5 of address 002A ₁₆) contents	
Timer mode	"0"	CNTR ₂ interrupt request occurrence: Falling edge ; No influence to timer count
	"1"	CNTR ₂ interrupt request occurrence: Rising edge ; No influence to timer count
Event counter mode	"0"	Timer Z: Rising edge count CNTR ₂ interrupt request occurrence: Falling edge
	"1"	Timer Z: Falling edge count CNTR ₂ interrupt request occurrence: Rising edge
Pulse output mode	"0"	Pulse output start: Beginning at "H" level CNTR ₂ interrupt request occurrence: Falling edge
	"1"	Pulse output start: Beginning at "L" level CNTR ₂ interrupt request occurrence: Rising edge
Pulse period measurement mode	"0"	Timer Z: Period from falling edge to the next falling edge measurement CNTR ₂ interrupt request occurrence: Falling edge
	"1"	Timer Z: Period from rising edge to the next rising edge measurement CNTR ₂ interrupt request occurrence: Rising edge
Pulse width measurement mode	"0"	Timer Z: "H" level width measurement CNTR ₂ interrupt request occurrence: Falling edge
	"1"	Timer Z: "L" level width measurement CNTR ₂ interrupt request occurrence: Rising edge
Programmable one-shot generating mode	"0"	Timer Z: after start outputting "L", "H" one-shot pulse generated CNTR ₂ interrupt request occurrence: Falling edge
	"1"	Timer Z: after start outputting "H", "L" one-shot pulse generated CNTR ₂ interrupt request occurrence: Rising edge

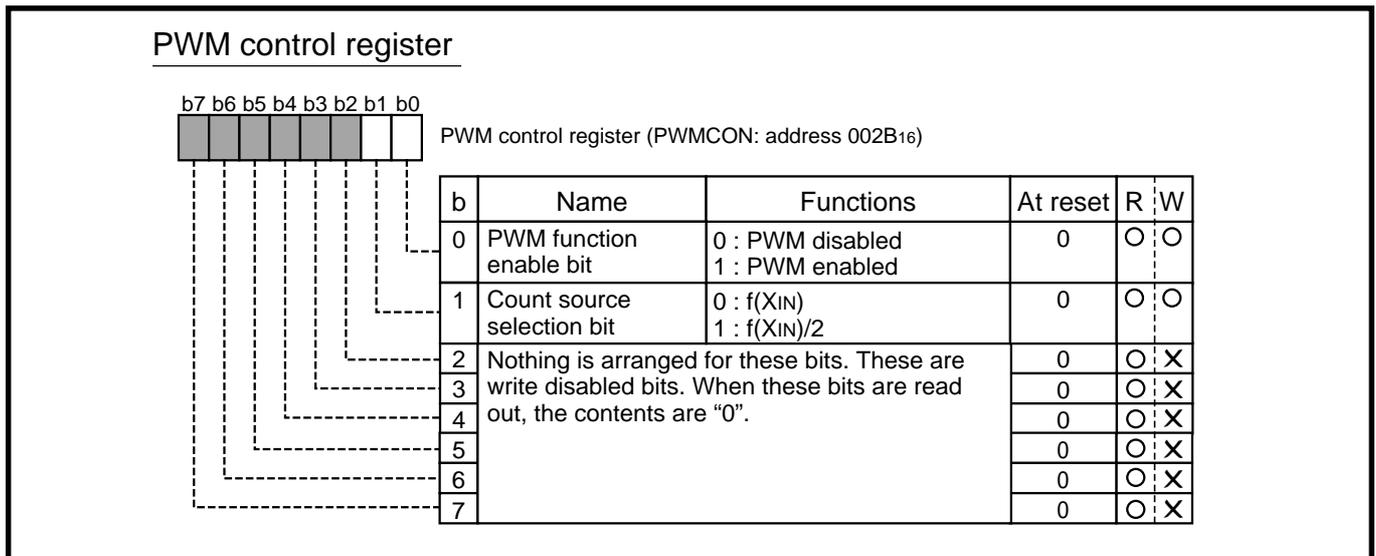


Fig. 4.20 Structure of PWM control register

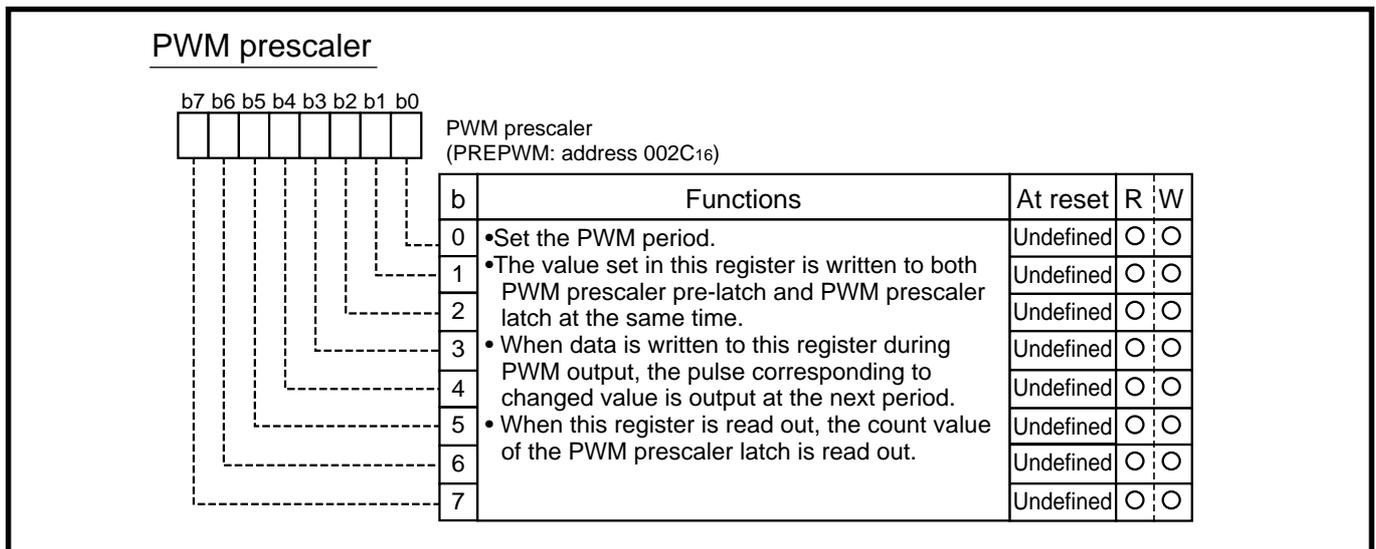


Fig. 4.21 Structure of PWM prescaler

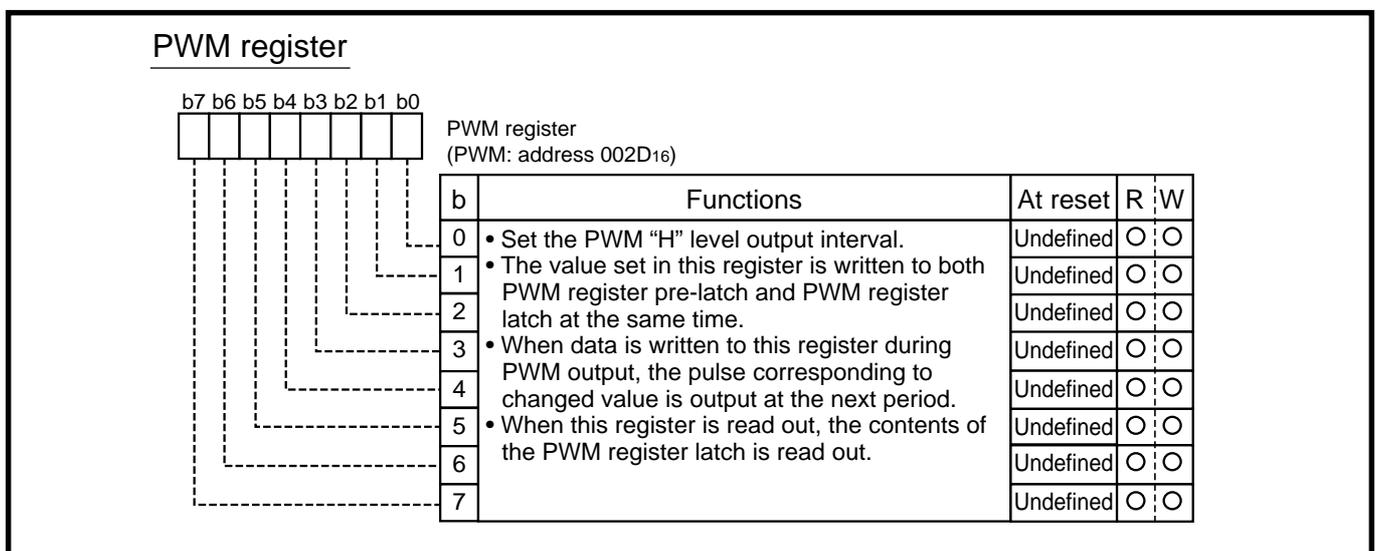


Fig. 4.22 Structure of PWM register

Serial I/O3 control register

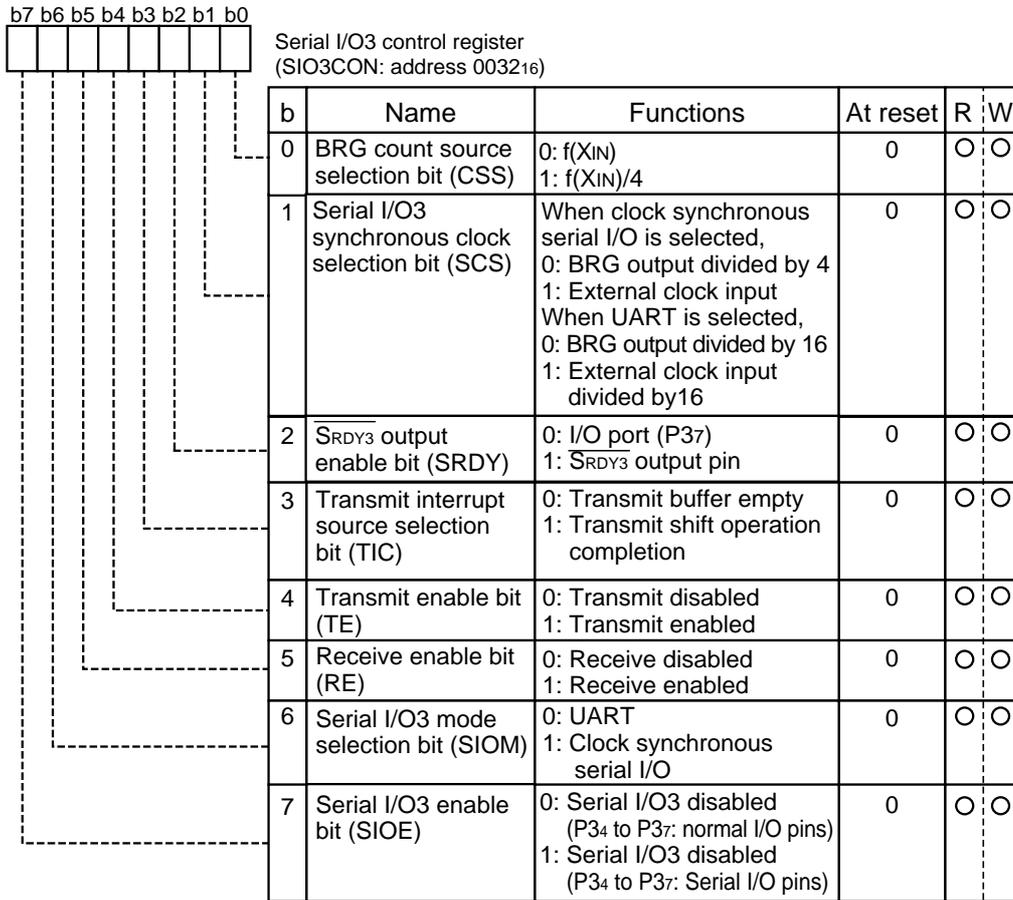


Fig. 4.23 Structure of Serial I/O3 control register

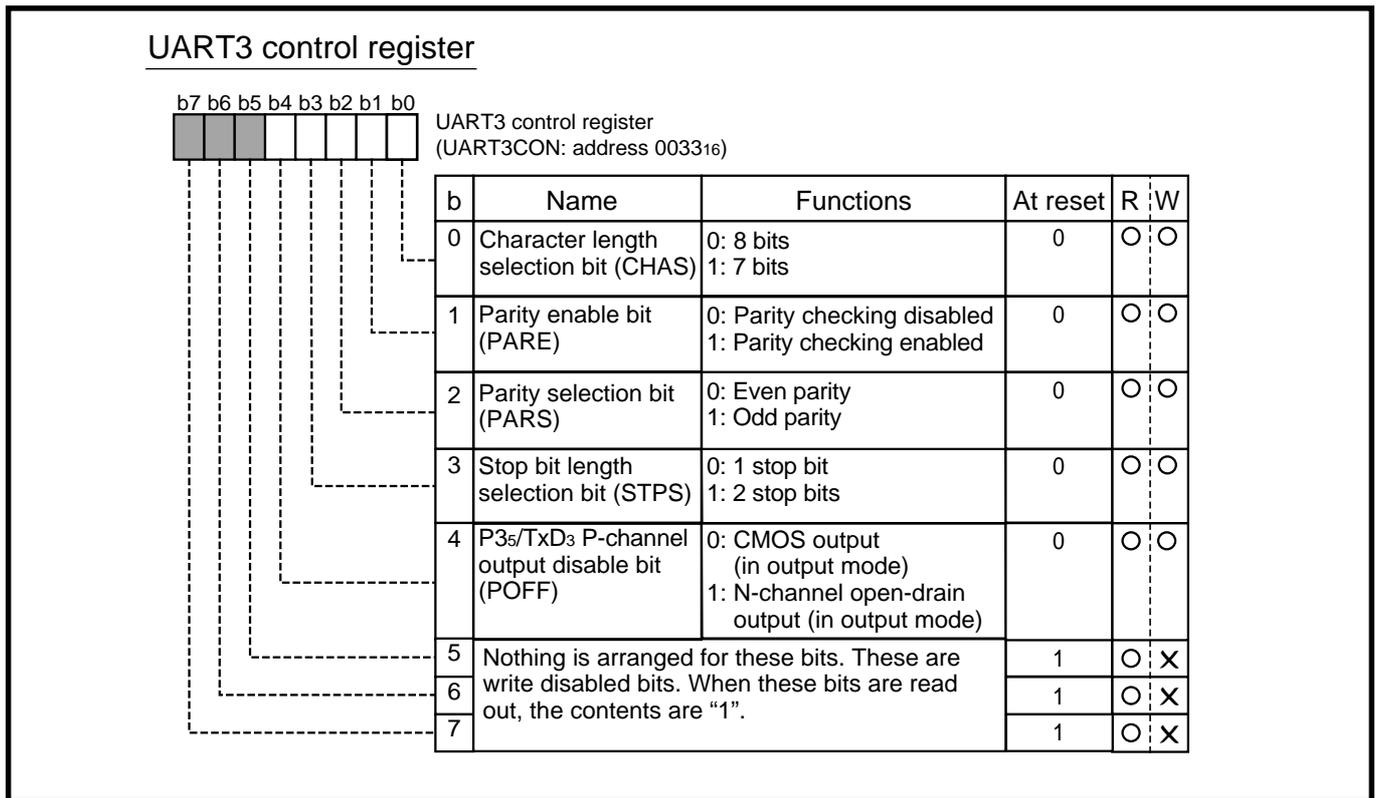


Fig. 4.24 Structure of UART3 control register

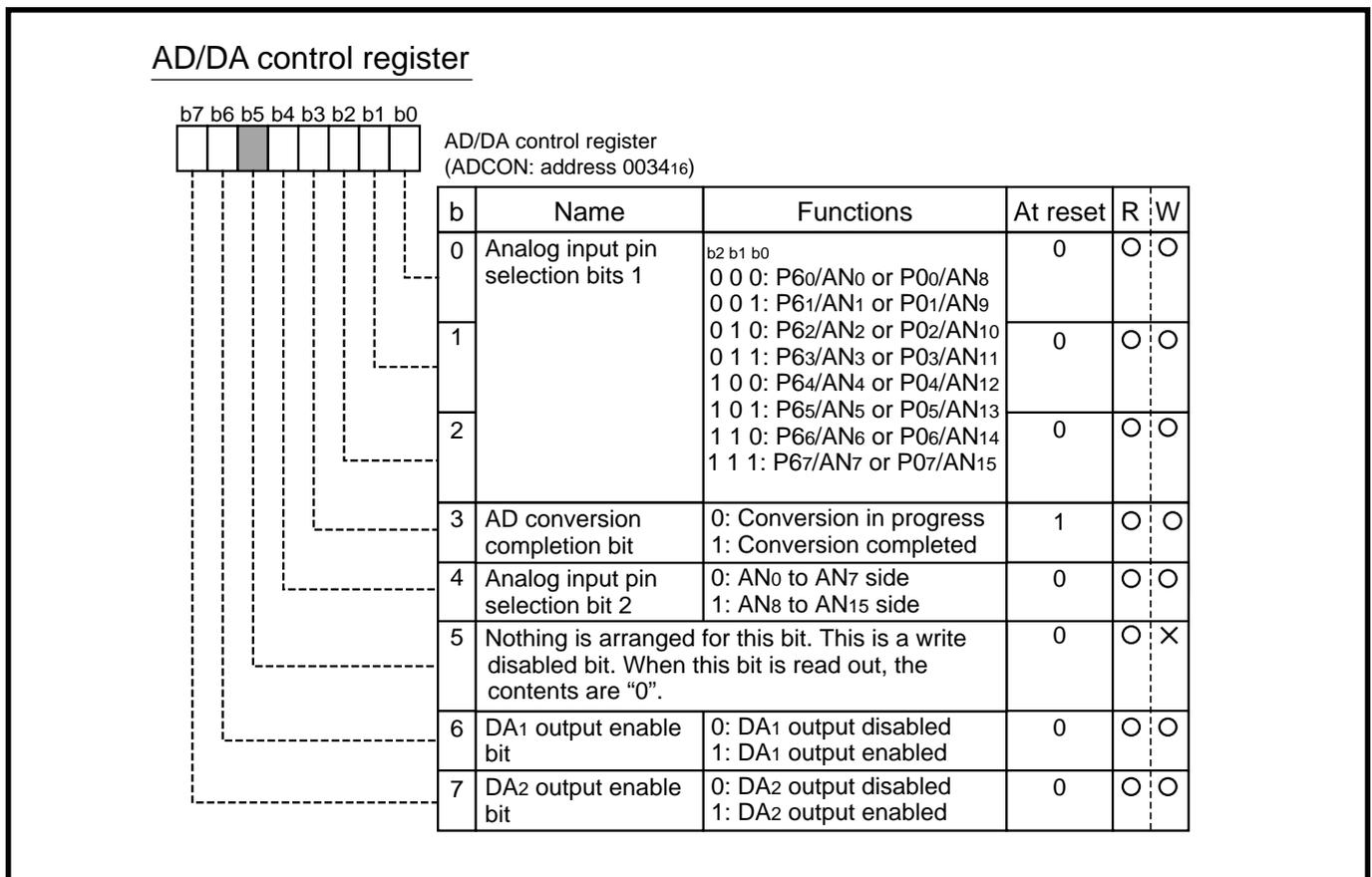


Fig. 4.25 Structure of AD/DA control register

A-D conversion register 1

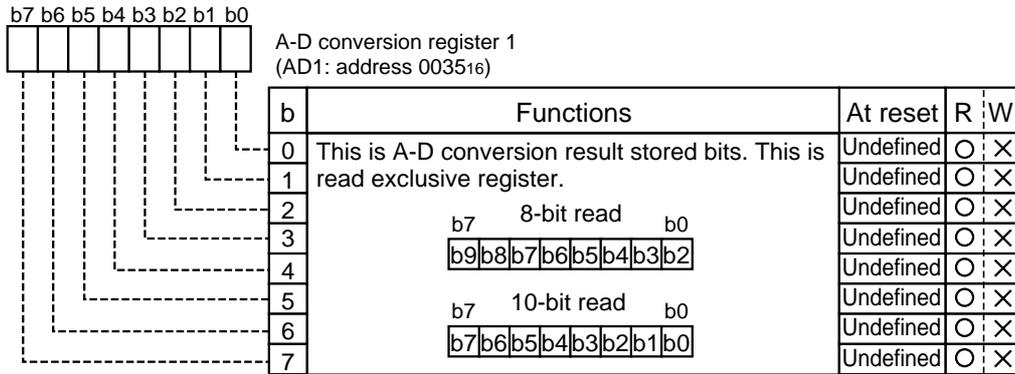


Fig. 4.26 Structure of A-D conversion register 1

D-Ai conversion register

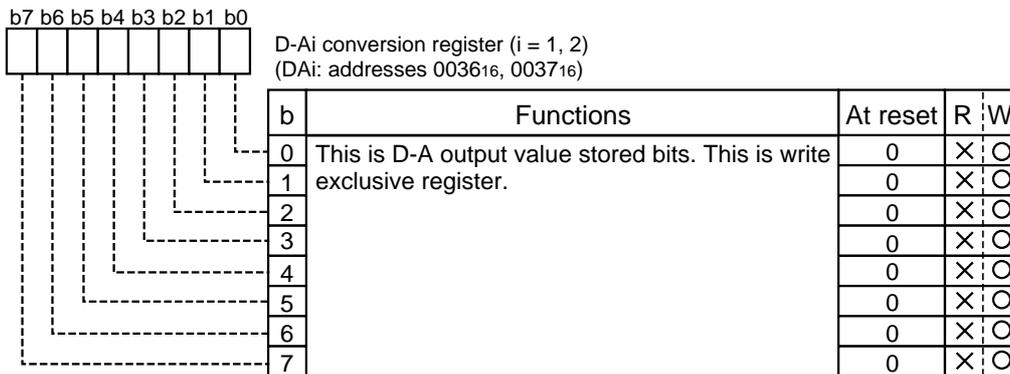


Fig. 4.27 Structure of D-Ai conversion register (i = 1, 2)

A-D conversion register 2

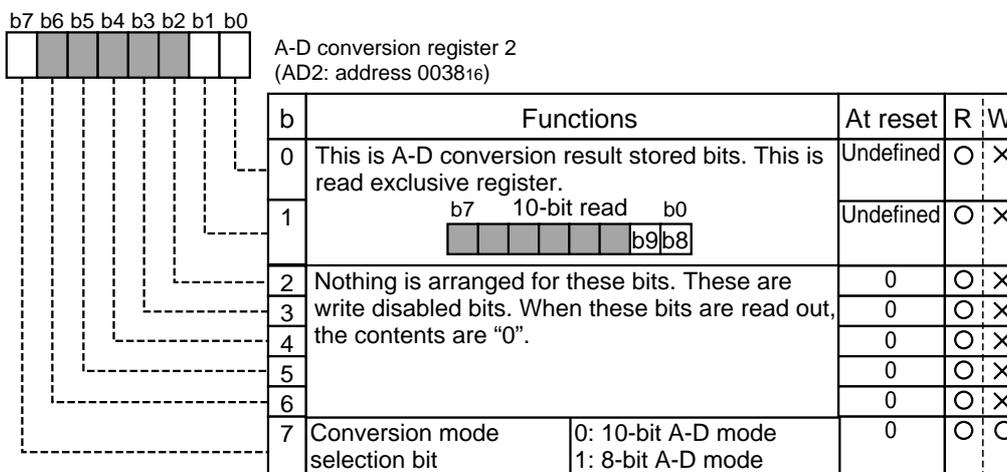


Fig. 4.28 Structure of A-D conversion register 2

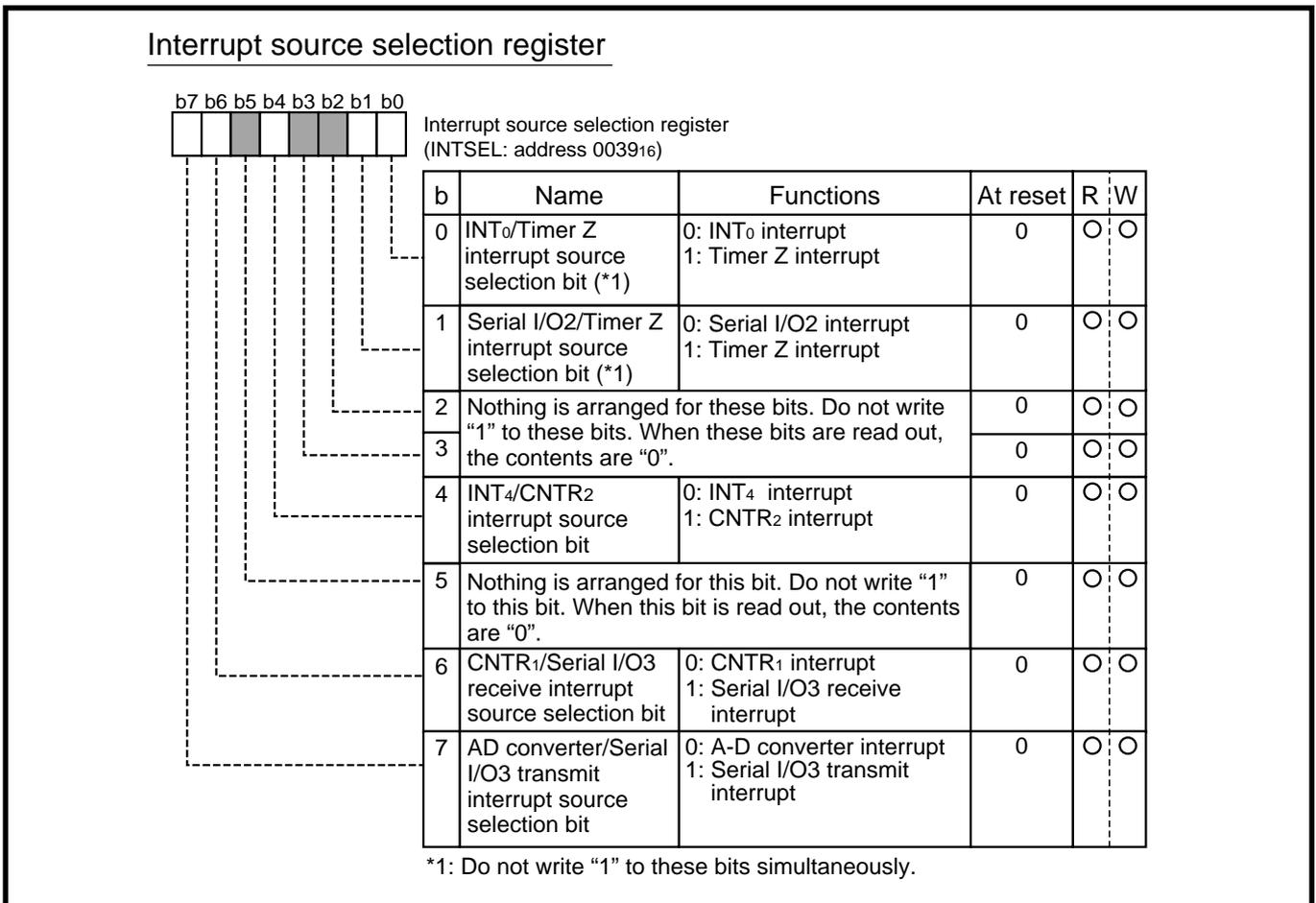


Fig. 4.29 Structure of Interrupt source selection register

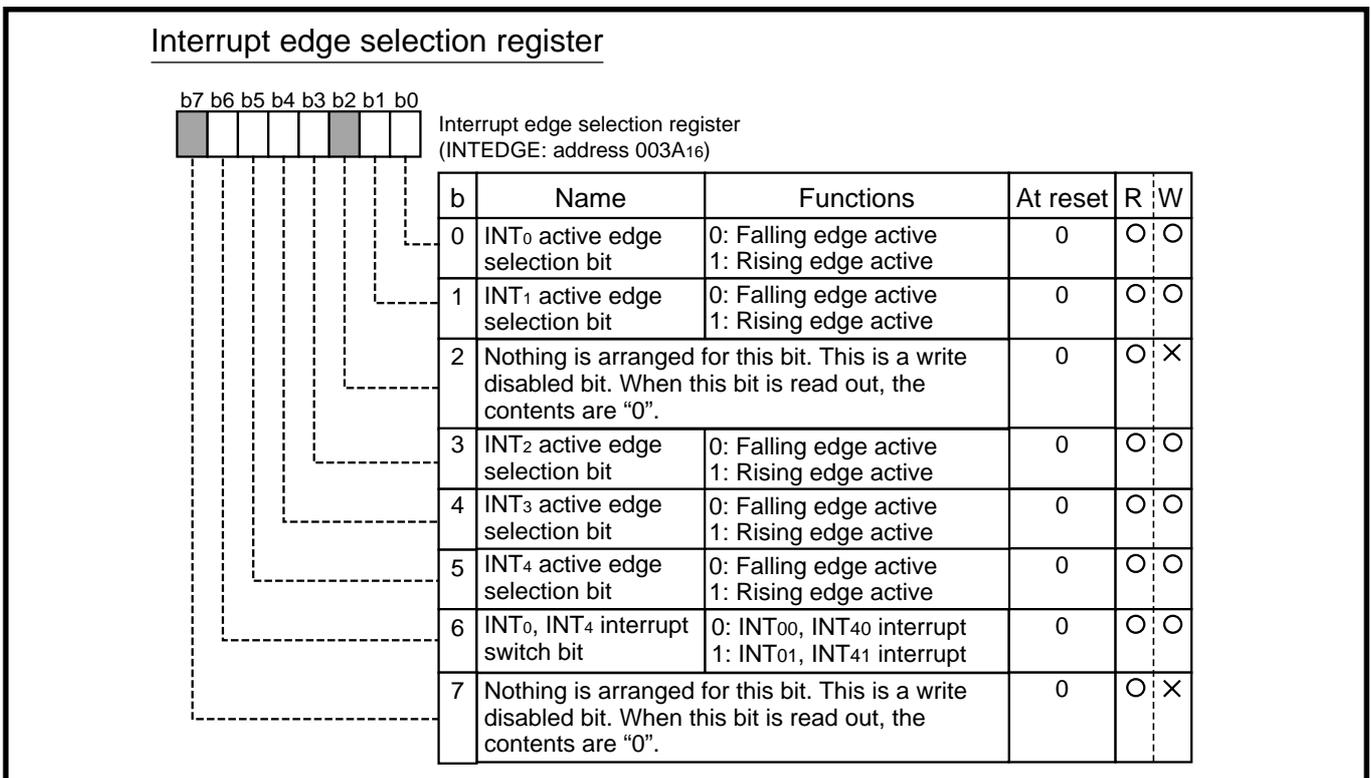


Fig. 4.30 Structure of Interrupt edge selection register

CPU mode register

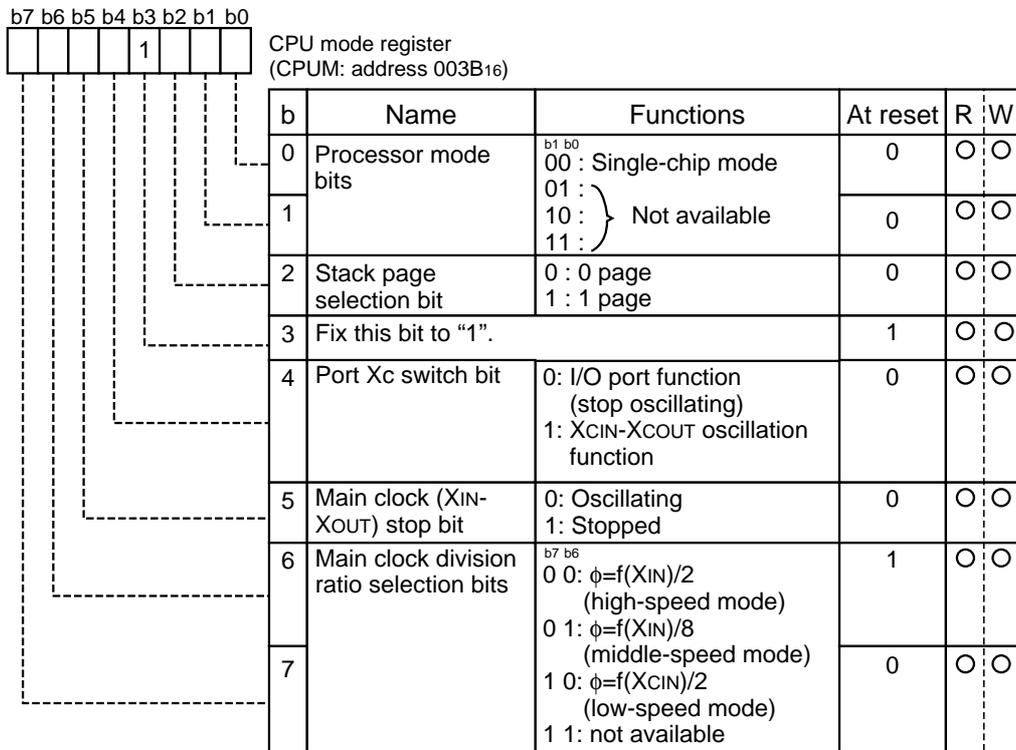


Fig. 4.31 Structure of CPU mode register

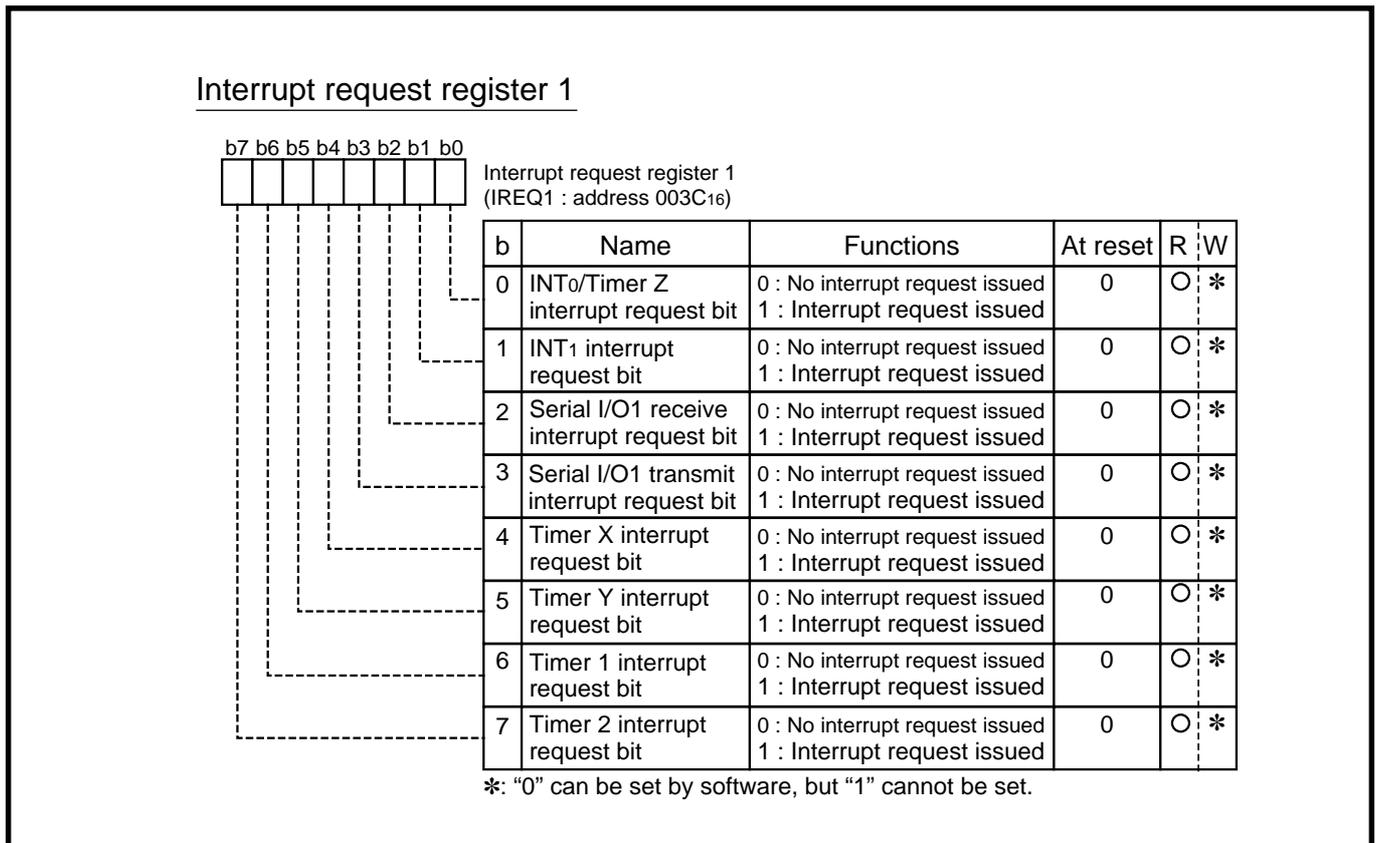


Fig. 4.32 Structure of Interrupt request register 1

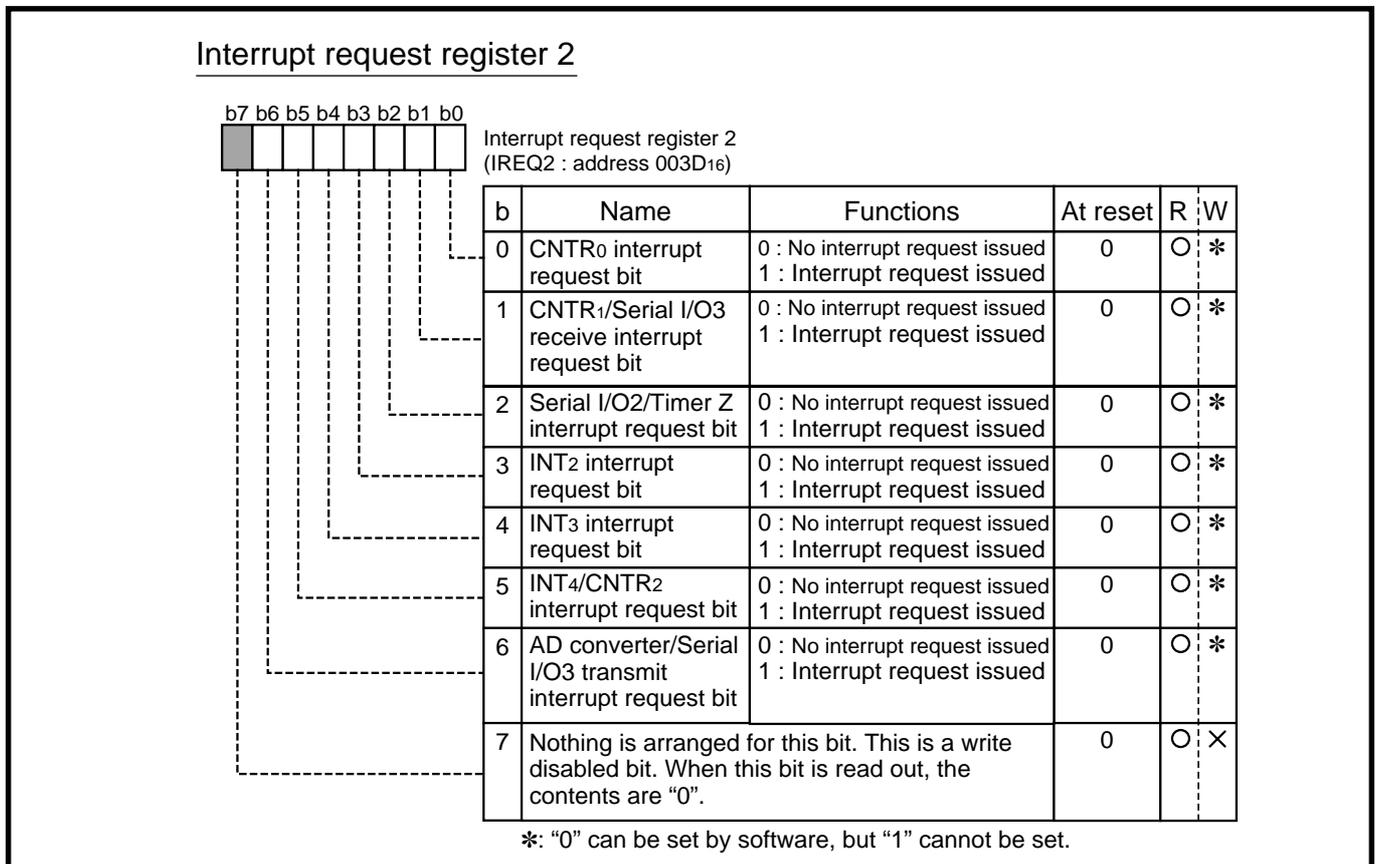


Fig. 4.33 Structure of Interrupt request register 2

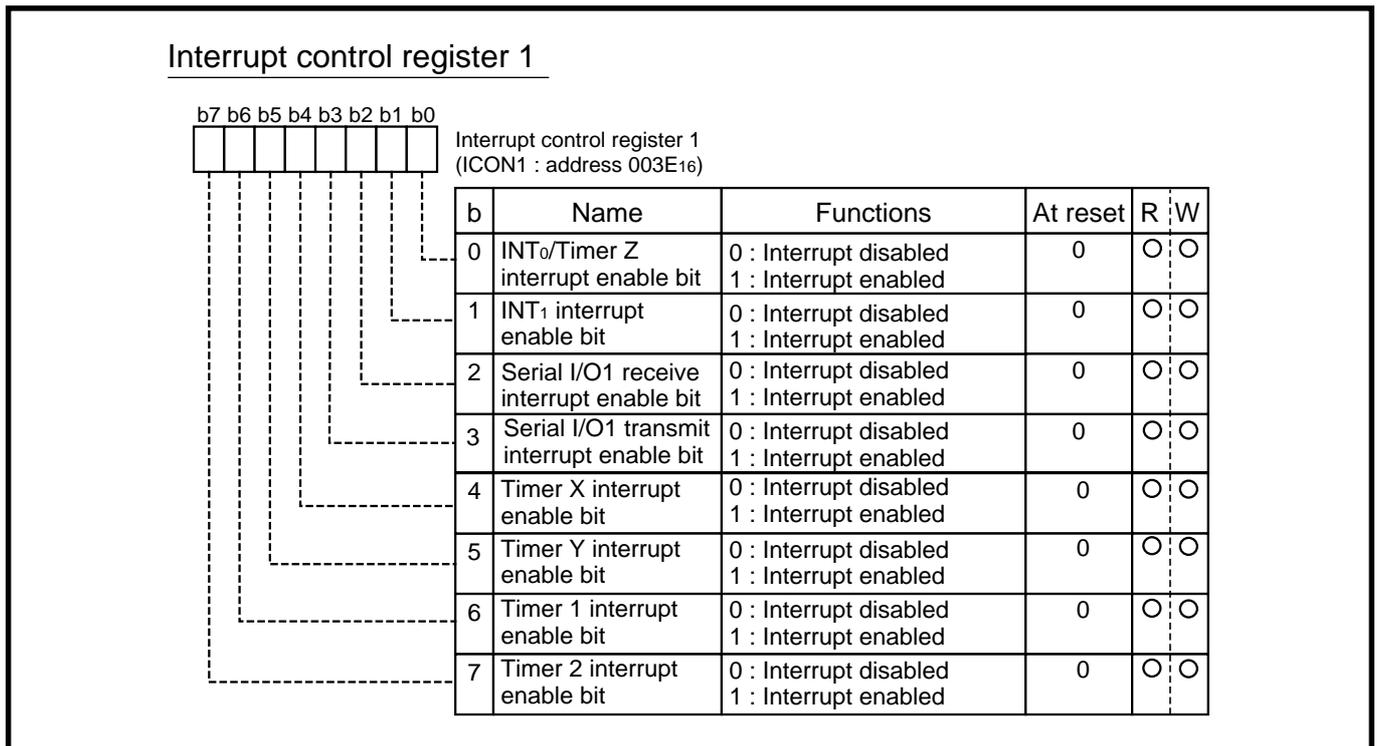


Fig. 4.34 Structure of Interrupt control register 1

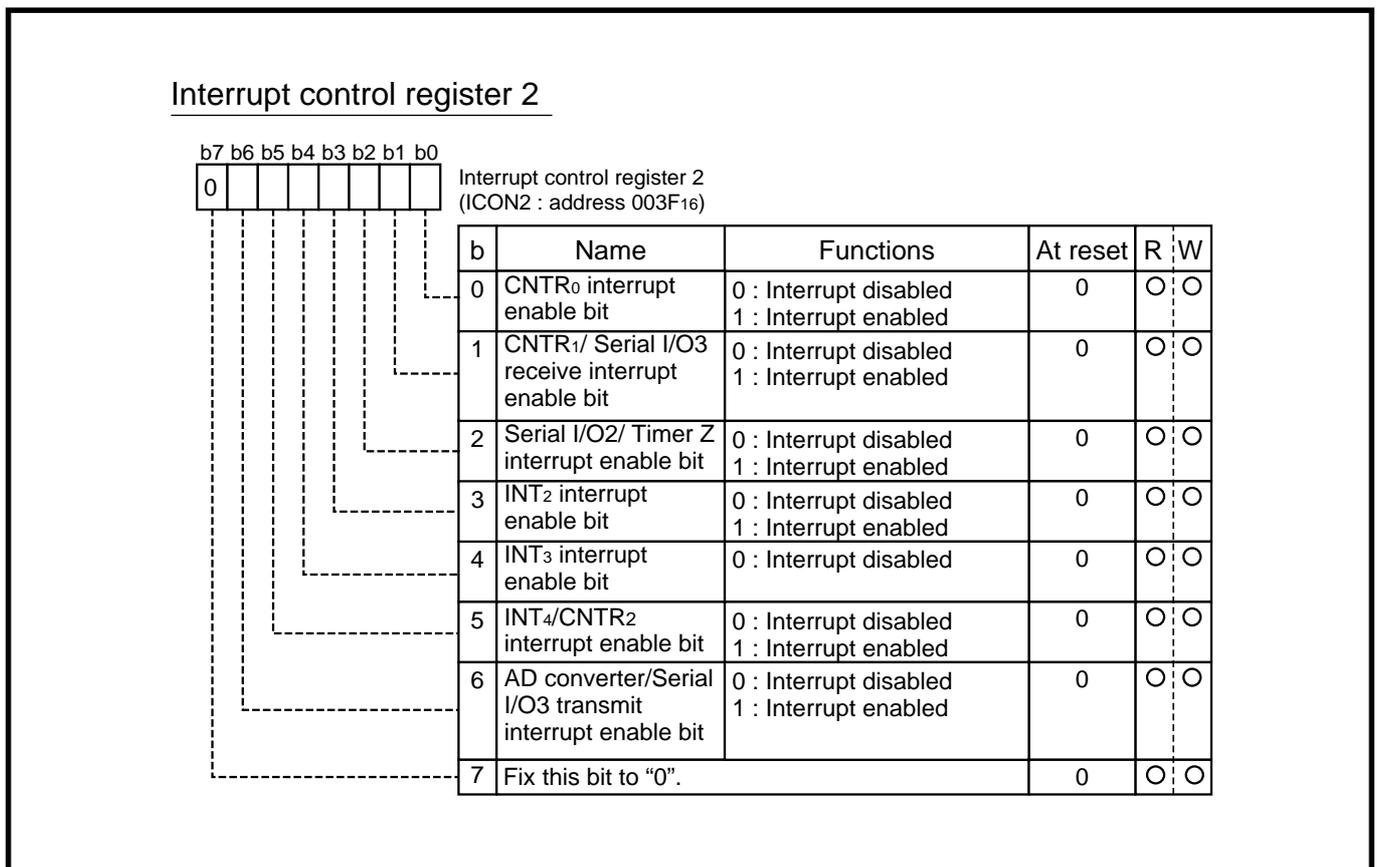
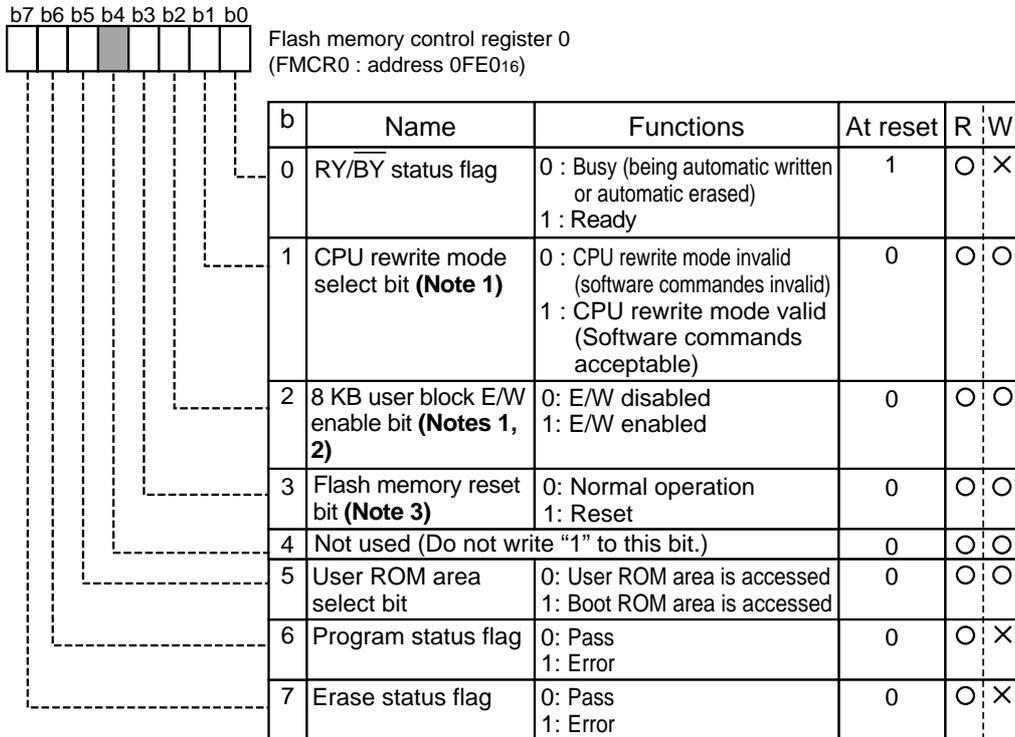


Fig. 4.35 Structure of Interrupt control register 2

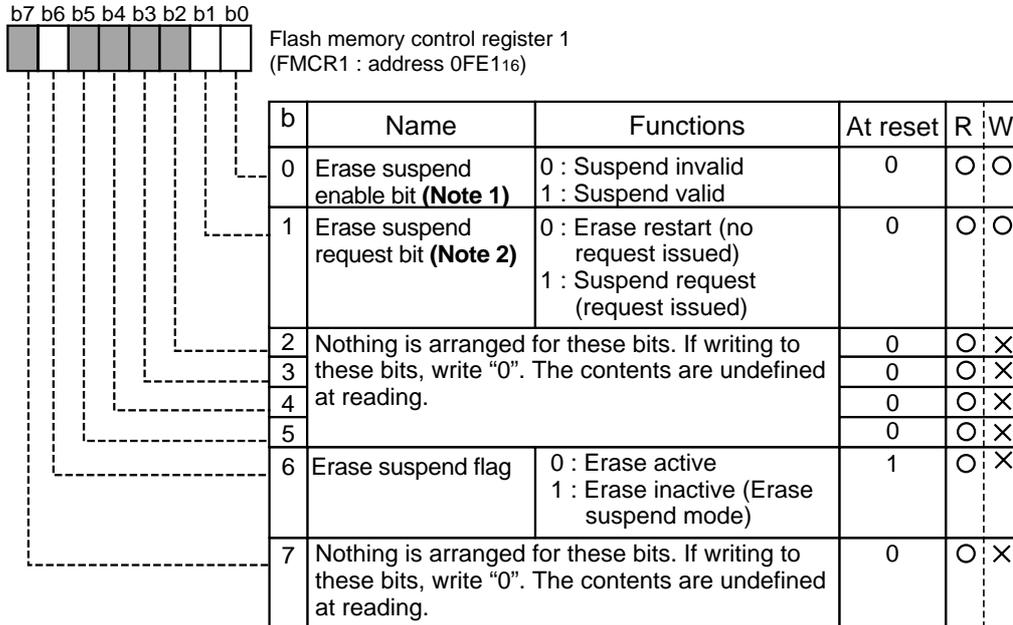
Flash memory control register 0



- Notes 1:** For this bit to be set to "1", the user needs to write a "0" and then a "1" to it in succession. For this bit to be set to "0", write "0" only to this bit.
- 2:** This bit can be written only when the CPU rewrite mode select bit is "1".
- 3:** Effective only when the CPU rewrite mode select bit = "1". Fix this bit to "0" when the CPU rewrite mode select bit is "0".
- 4:** When setting this bit to "1" (when the control circuit of flash memory is reset), the flash memory cannot be accessed for 10 μs.
- 5:** Write to this bit from program on RAM.

Fig. 4.36 Structure of Flash memory control register 0 (Flash memory version only)

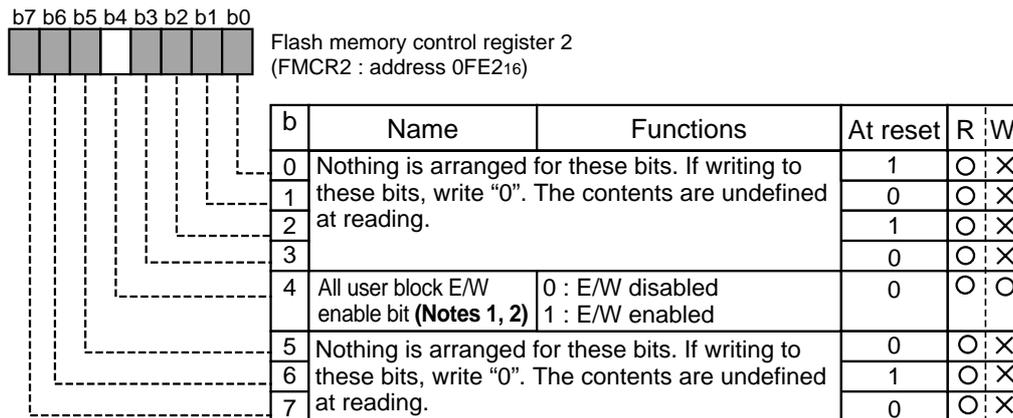
Flash memory control register 1



Notes 1: For this bit to be set to "1", the user needs to write a "0" and then a "1" to it in succession.
2: Only when the erase suspend bit is "1", this bit is valid.

Fig. 4.37 Structure of Flash memory control register 1 (Flash memory version only)

Flash memory control register 2



Notes 1: For this bit to be set to "1", the user needs to write a "0" and then a "1" to it in succession.
2: Effective only when the CPU rewrite mode select bit = "1".

Fig. 4.38 Structure of Flash memory control register 2 (Flash memory version only)

Port Pi pull-up control register (i = 0 to 2, 4 to 6)

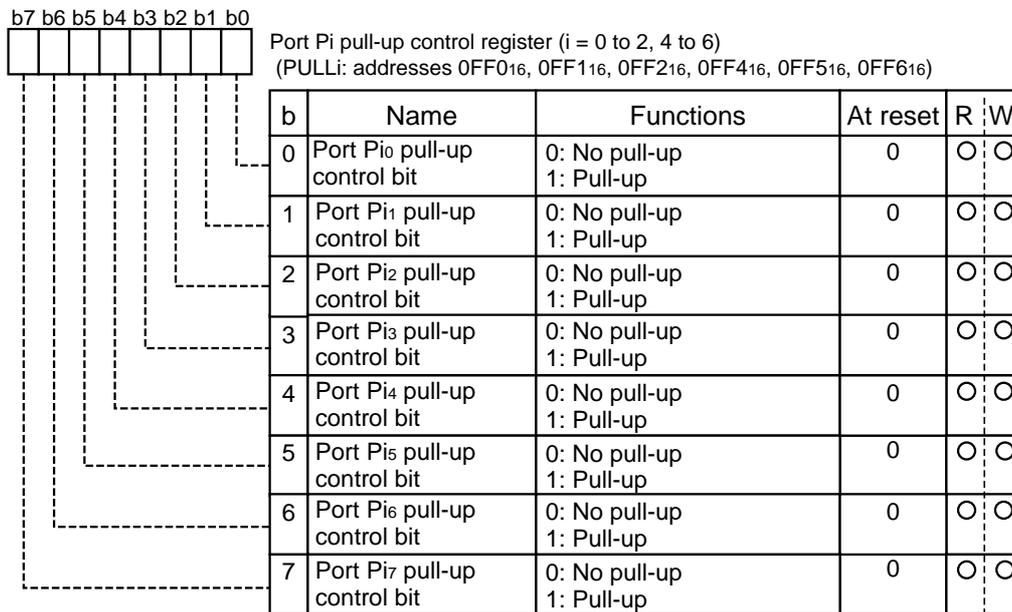


Fig. 4.39 Structure of Port Pi pull-up control register (i = 0 to 2, 4 to 6)

Port P3 pull-up control register

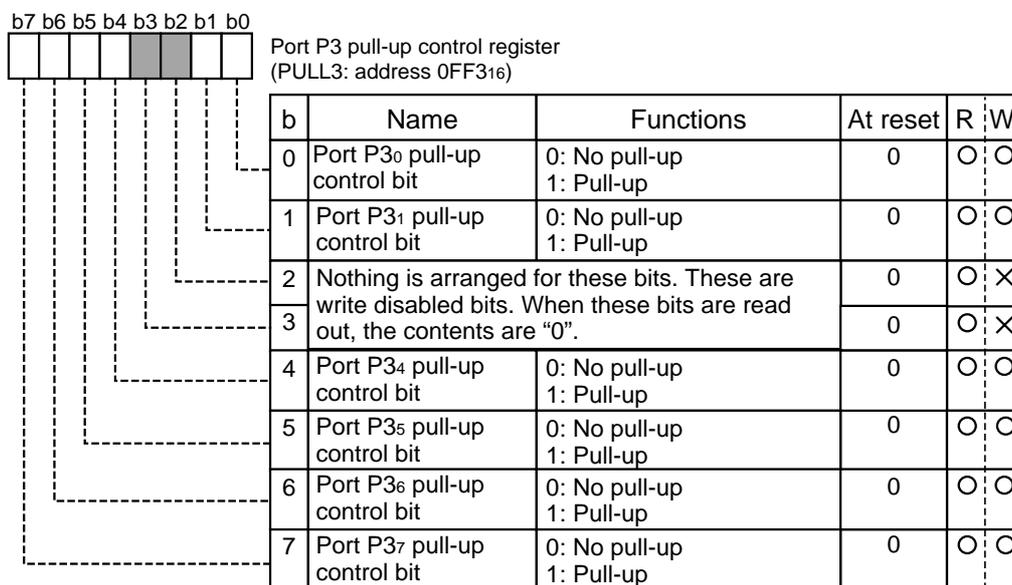


Fig. 4.40 Structure of Port P3 pull-up control register

5. Reference Program Example

Please find the reference program on the Renesas Technology website.
Click the upper left menu of the screen "Application Notes" on the 740 family.

6. Reference

Data Sheet
3803 Group (Spec.H) Data Sheet

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REVISION HISTORY	3803 Group (Spec.H) List of registers
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Rev.	Date	Description	
		Page	Summary
1.00	Nov 14, 2005	-	This application note is issued using the information of "Chapter 3.5 List of registers" in the 3803 Group (Spec.H) User's Manual Rev.2.02.

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